TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSVI)

# 2SK2989

Chopper Regulator, DC-DC Converter and Motor Drive Applications

Low drain-source ON resistance : R<sub>DS (ON)</sub> = 120 mΩ (typ.)

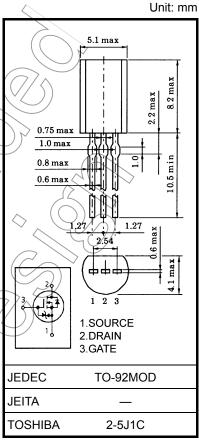
• High forward transfer admittance :  $|Y_{fs}| = 2.6 \text{ S (typ.)}$ 

• Low leakage current :  $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 50 \text{ V)}$ 

• Enhancement-mode :  $V_{th}$  = 1.0 to 2.2 V ( $V_{DS}$  = 10 V,  $I_D$  = 1 mA)

## Absolute Maximum Ratings (Ta = 25°C)

Characteris	tics	Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	50	٧
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	50	V
Gate-source voltage		V <sub>GSS</sub>	±20	//v
Drain current	DC (Note 1)	ID	5	A
	Pulse (Note 1)	IDP	)) 15	(
Drain power dissipation		(PD \	0.9	/ w
Channel temperature		T <sub>ch</sub>	150	),¢
Storage temperature ra	inge	\_\_\(\tag\)	-55 to 150	ွှင့်



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### Thermal Characteristics

Characteristics Symbol	Max	Unit
Thermal resistance, channel to ambient Rth (ch-a)	138	°C/W

Note 1: Rlease use devices on condition that the channel temperature is below 150°C.

This transistor is an electrostatic sensitive device.

Please handle with caution.

# **Electrical Characteristics (Ta = 25°C)**

Chara	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Drain cut-off cu	ırrent	I <sub>DSS</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V	_	_	100	μΑ
Drain-source b	reakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	50	_	_	V
Gate threshold	voltage	$V_{th}$	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.0		2.2	V
Drain-source ON resistance		R <sub>DS</sub> (ON)	V <sub>GS</sub> = 4 V, I <sub>D</sub> = 1.3 A		240	330	- mΩ
			V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.5 A		120	150	
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.5 A	3.3	2.6	_	S
Input capacitance		C <sub>iss</sub>		)	145	_	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	` —	25	_	pF
Output capacitance		Coss		_	75	_	
Switching time	Rise time	t <sub>r</sub>	$V_{\rm GS} \stackrel{10V}{\underset{\rm OV}{\prod}} \stackrel{I_{\rm D}=2.5{\rm A}}{\underset{\rm R_L=10\Omega}{\bigvee}} V_{\rm OUT}$	- (	16	>	
	Turn-on time	t <sub>on</sub>			23	) _	
	Fall time	t <sub>f</sub>	v <sub>DD</sub> =25V		27	_	ns
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\rm w} = 10 \mu \rm s$	) –	110	_	
Total gate charg plus gate-drain		Qg		_	6.5	_	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 40 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	_	5	_	nC
Gate-drain ("mi	ller") Charge	Qgd		_	1.5	_	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>		_	_	5	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	ı	_	15	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 5 A, V <sub>GS</sub> = 0 V	1	_	-1.5	V

### Marking

Part No. (or abbreviation code)

Lot No.

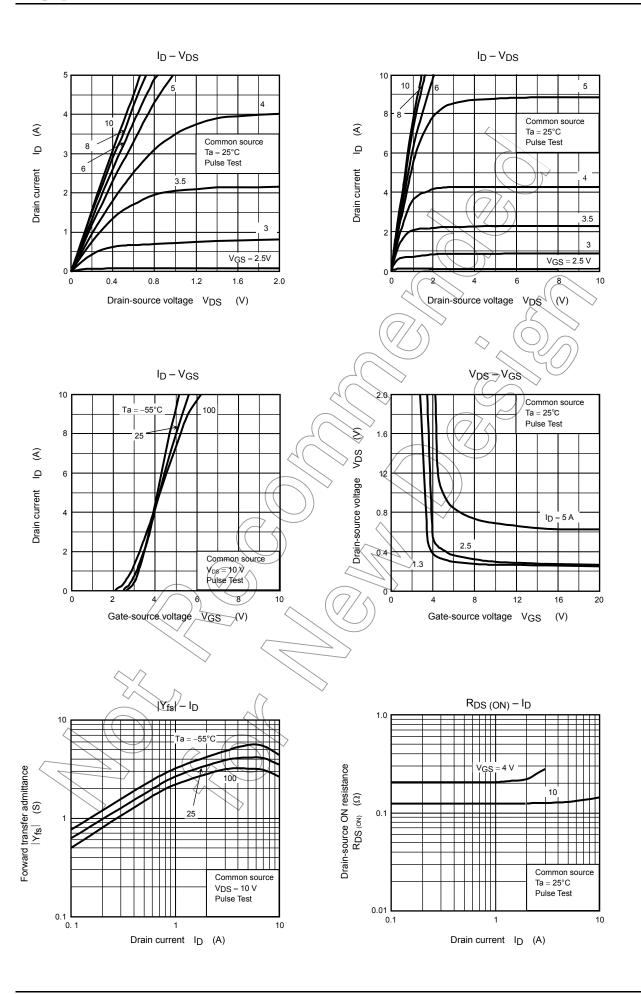
Note 2

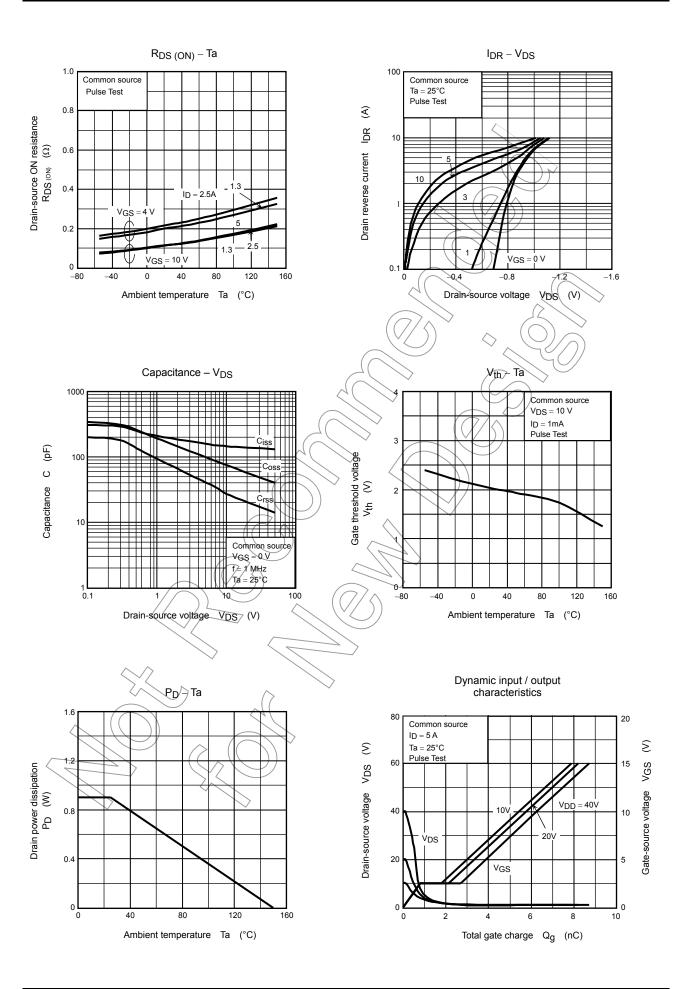
Note 2: A line under a Lot No. identifies the indication of product Labels.

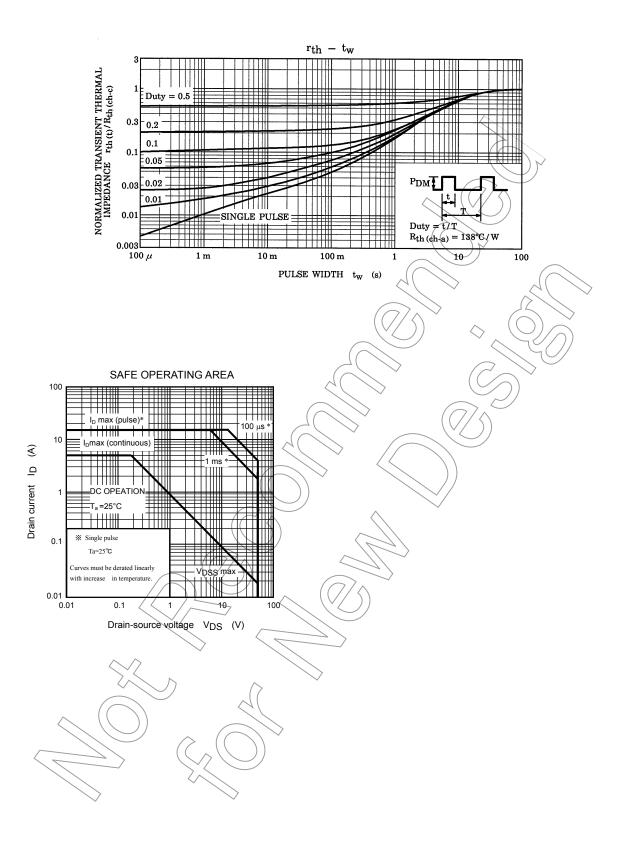
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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2 2009-09-29







5 2009-09-29

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6